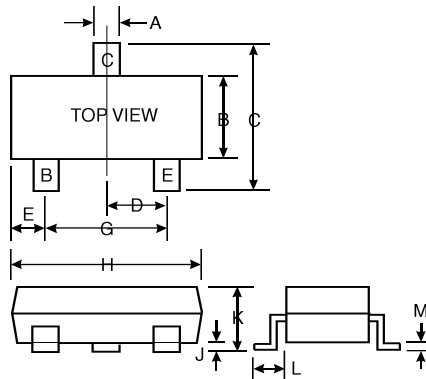


### Features

Epitaxial Planar Die Construction  
Complementary PNP Type Available  
(MMST4403)  
Ultra-Small Surface Mount Package

### Mechanical Data

Case: SOT-323, Molded Plastic  
Terminals: Solderable per MIL-STD-202,  
Method 208  
Terminal Connections: See Diagram  
Marking: K3X  
Weight: 0.006 grams (approx.)



SOT-323		
Dim	Min	Max
A	0.30	0.40
B	1.15	1.35
C	2.00	2.20
D	0.65 Nominal	
E	0.30	0.40
G	1.20	1.40
H	1.80	2.20
J	0.0	0.10
K	0.90	1.00
L	0.25	0.40
M	0.10	0.25
All Dimensions in mm		

### Maximum Ratings @ $T_A = 25\text{ C}$ unless otherwise specified

Characteristic	Symbol	MMST4401	Unit
Collector-Base Voltage	$V_{CBO}$	60	V
Collector-Emitter Voltage	$V_{CEO}$	40	V
Emitter-Base Voltage	$V_{EBO}$	6.0	V
Collector Current - Continuous (Note 1)	$I_C$	600	mA
Power Dissipation (Note 1)	$P_d$	200	mW
Thermal Resistance, Junction to Ambient (Note 1)	$R_{JA}$	625	K/W
Operating and Storage and Temperature Range	$T_j, T_{STG}$	-55 to +150	C

- Notes: 1. Valid provided that terminals are kept at ambient temperature.  
2. Pulse test: Pulse width 300 s, duty cycle 2%.

**Electrical Characteristics** @  $T_A = 25\text{ C}$  unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition
<b>OFF CHARACTERISTICS (Note 2)</b>					
Collector-Base Breakdown Voltage	$V_{(BR)CBO}$	60		V	$I_C = 100\text{ A}, I_E = 0$
Collector-Emitter Breakdown Voltage	$V_{(BR)CEO}$	40		V	$I_C = 1.0\text{mA}, I_B = 0$
Emitter-Base Breakdown Voltage	$V_{(BR)EBO}$	6.0		V	$I_E = 100\text{ A}, I_C = 0$
Collector Cutoff Current	$I_{CEX}$		100	nA	$V_{CE} = 35\text{V}, V_{EB(OFF)} = 0.4\text{V}$
Base Cutoff Current	$I_{BL}$		100	nA	$V_{CE} = 35\text{V}, V_{EB(OFF)} = 0.4\text{V}$
<b>ON CHARACTERISTICS (Note 2)</b>					
DC Current Gain	$h_{FE}$	20 40 80 100 40	300		$I_C = 100\mu\text{A}, V_{CE} = 1.0\text{V}$ $I_C = 1.0\text{mA}, V_{CE} = 1.0\text{V}$ $I_C = 10\text{mA}, V_{CE} = 1.0\text{V}$ $I_C = 150\text{mA}, V_{CE} = 1.0\text{V}$ $I_C = 500\text{mA}, V_{CE} = 2.0\text{V}$
Collector-Emitter Saturation Voltage	$V_{CE(SAT)}$		0.40 0.75	V	$I_C = 150\text{mA}, I_B = 15\text{mA}$ $I_C = 500\text{mA}, I_B = 50\text{mA}$
Base- Emitter Saturation Voltage	$V_{BE(SAT)}$	0.75	0.95 1.2	V	$I_C = 150\text{mA}, I_B = 15\text{mA}$ $I_C = 500\text{mA}, I_B = 50\text{mA}$
<b>SMALL SIGNAL CHARACTERISTICS</b>					
Output Capacitance	$C_{cb}$		6.5	pF	$V_{CB} = 5.0\text{V}, f = 1.0\text{MHz}, I_E = 0$
Input Capacitance	$C_{eb}$		30	pF	$V_{EB} = 0.5\text{V}, f = 1.0\text{MHz}, I_C = 0$
Input Impedance	$h_{ie}$	1.0	15	k	$V_{CE} = 10\text{V}, I_C = 1.0\text{mA},$ $f = 1.0\text{kHz}$
Voltage Feedback Ratio	$h_{re}$	0.1	8.0	$\times 10^{-4}$	
Small Signal Current Gain	$h_{fe}$	40	500		
Output Admittance	$h_{oe}$	1.0	30	S	
Current Gain-Bandwidth Product	$f_T$	250		MHz	$V_{CE} = 10\text{V}, I_C = 20\text{mA},$ $f = 100\text{MHz}$
<b>SWITCHING CHARACTERISTICS</b>					
Delay Time	$t_d$		15	ns	$V_{CC} = 30\text{V}, I_C = 150\text{mA},$ $V_{BE(off)} = 2.0\text{V}, I_{B1} = 15\text{mA}$
Rise Time	$t_r$		20	ns	
Storage Time	$t_s$		225	ns	$V_{CC} = 30\text{V}, I_C = 150\text{mA},$ $I_{B1} = I_{B2} = 15\text{mA}$
Fall Time	$t_f$		30	ns	

- Notes: 1. Valid provided that terminals are kept at ambient temperature.  
2. Pulse test: Pulse width 300  $\mu\text{s}$ , duty cycle 2%.